TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

SSM5N16FE

High Speed Switching Applications Analog Switching Applications

· Suitable for high-density mounting due to compact package

• Low on resistance: $R_{on} = 3.0 \Omega \text{ (max) } (@V_{GS} = 4 \text{ V})$

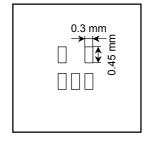
: $R_{on} = 4.0 \Omega \text{ (max) } (@V_{GS} = 2.5 \text{ V})$

: $R_{on} = 15 \Omega (max) (@V_{GS} = 1.5 V)$

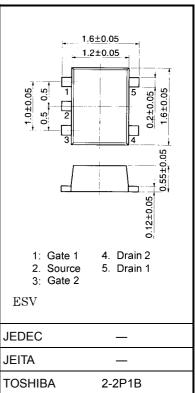
Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V_{DS}	20	V	
Gate-Source voltage		V _{GSS}	±10	V	
Drain current	DC	ID	100	mA	
	Pulse	I _{DP}	200		
Drain power dissipation (Ta = 25°C)		P _D (Note)	150	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Note: Total rating, mounted on FR4 board (25.4 mm \times 25.4 mm \times 1.6 t, Cu Pad: 0.135 mm² \times 5)

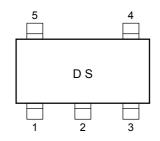


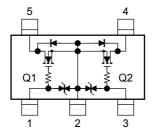
Unit: mm



Marking

Equivalent Circuit





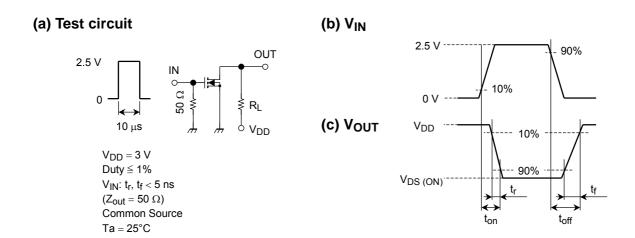
Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Electrical Characteristics (Ta = 25°C) (Q1, Q2 Common)

Charac	cteristics Symbol Test Condition		Min	Тур.	Max	Unit	
Gate leakage current		I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	_	_	±1	μΑ
Drain-Source breakdown voltage		V (BR) DSS	$I_D = 0.1 \text{ mA}, V_{GS} = 0$	20	_	_	V
Drain cut-off currer	nt	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0$	_	_	1	μΑ
Gate threshold volt	age	V _{th}	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.6	_	1.1	V
Forward transfer ad	dmittance	Y _{fs}	$V_{DS} = 3 \text{ V}, I_D = 10 \text{ mA}$	40	_	_	mS
		R _{DS} (ON)	$I_D = 10$ mA, $V_{GS} = 4$ V	_	1.5	3.0	Ω
Drain-Source ON resistance	$I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$		_	2.2	4.0		
			$I_D = 1 \text{ mA}, V_{GS} = 1.5 \text{ V}$	_	5.2	15	
Input capacitance		C _{iss}	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	9.3	_	pF
Reverse transfer ca	apacitance	C _{rss}	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	4.5	_	pF
Output capacitance		Coss	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	9.8	_	pF
Switching time	Turn-on time	t _{on}	$V_{DD} = 3 \text{ V}, I_D = 10 \text{ mA}, V_{GS} = 0~2.5 \text{ V}$	_	70	_	ns
	Turn-off time	t _{off}		_	125	_	

Switching Time Test Circuit



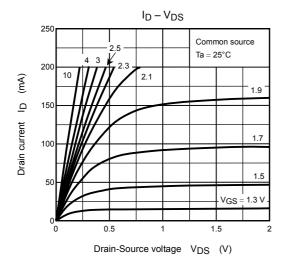
Precaution

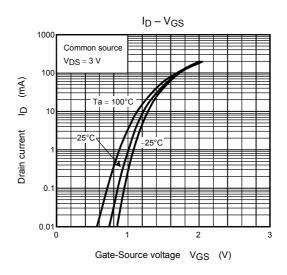
 V_{th} can be expressed as voltage between gate and source when low operating current value is I_D = 100 μA for this product. For normal switching operation, V_{GS} (on) requires higher voltage than V_{th} and V_{GS} (off) requires lower voltage than V_{th} . (Relationship can be established as follows: V_{GS} (off) < V_{th} < V_{GS} (on))

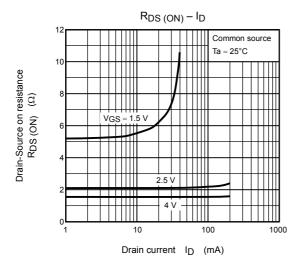
Please take this into consideration for using the device. $V_{\rm GS}$ recommended voltage of 1.5 V or higher to turn on this product.

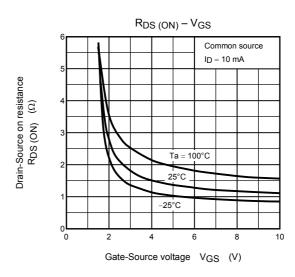
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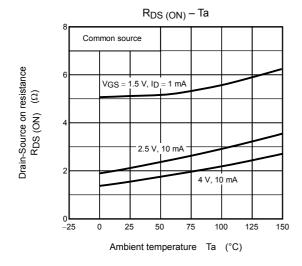
(Q1, Q2 common)

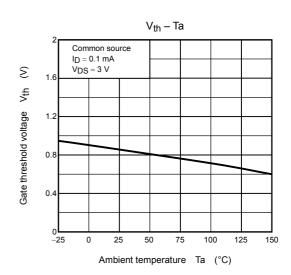






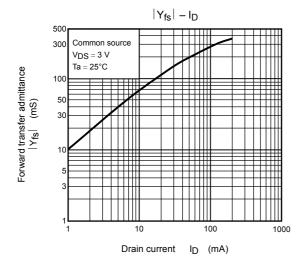


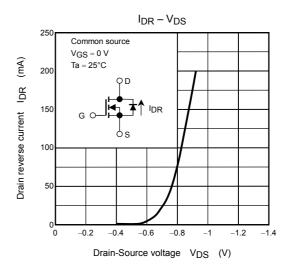


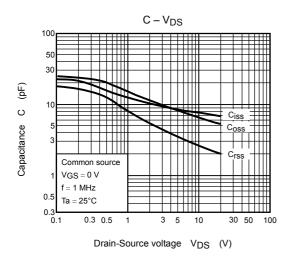


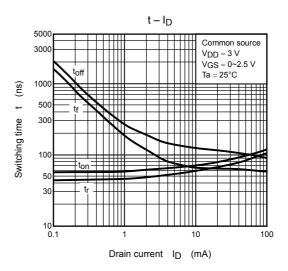
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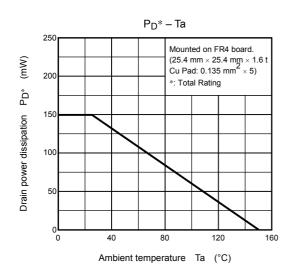
(Q1, Q2 common)











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